

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1963aet-3.3#06pbf

(Engineering Calculation)

TO-220

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**TOTAL MASS (g) : 1.98847**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003006	1000000	1511.71484375		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	1.428754	998500	718519.125		
		Iron (Fe)	7439-89-6	0.000000	0	0		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.002146	1500	1079.22155762		
<b>Lead Frame Total:</b>				<b>1.430900</b>	<b>1000000</b>	<b>719598.375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.011398	1000000	5732.17919922		
		<b>External Plating Total:</b>				<b>0.011398</b>	<b>1000000</b>	<b>5732.17919922</b>
		Inter. Plating Ni	7440-02-0	0.010000	834028.375	5028.99121094		
		Inter. Plating Ag	7440-22-4	0.001990	165971.640625	1000.76934814		
<b>Internal Plating Total:</b>				<b>0.011990</b>	<b>1000000</b>	<b>6029.76025391</b>		
Die Attach	95Pb / 5 Sn	Silver (Ag)	7440-22-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000080	50000	40.2319297791		
		Lead (Pb)	7439-92-1	0.001512	950000	760.383483887		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000000	0	0		
<b>Die Attach Total:</b>				<b>0.001592</b>	<b>1000000</b>	<b>800.61541748</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.054270	103000	27292.3359375		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.471567	895000	237150.640625		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.001054	2000	530.055664062		
		<b>Encapsulation Total:</b>				<b>0.526891</b>	<b>1000000</b>	<b>264973</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000547	1000000	275.08581543		
					<b>TOTAL MASS (g) :</b>	<b>1.98847</b>		